

Electronic Patent Application Fee Transmittal

Application Number:	10599661
Filing Date:	
Title of Invention:	Palladium-plated Lead Finishing Structure For Semiconductor Part And Method Of Producing Semiconductor Device
First Named Inventor:	Kazumitsu Seki
Filer:	Joseph A. Calvaruso/Susan Shen-Frattura
Attorney Docket Number:	17314018

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

National Stage Fee	1631	1	300	300
National Stage Search - all other cases	1632	1	500	500
National Stage Exam - all other cases	1633	1	200	200

Pages:

Claims:				
Independent claims in excess of 3	1614	1	200	200

Miscellaneous-Filing:

Petition:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Miscellaneous:				
				Total in USD (\$)
				1200